

CONTROL DEVICES

T-07-15

HIGH VOLTAGE PIN DIODES

DESCRIPTION

The GC4400 series are high voltage, high power (cathode base) PIN diodes. These double diffused high resistivity silicon devices are passivated with silicon dioxide for high stability and reliability and have been proven by thousands of device hours in high reliability systems.

Each device can withstand storage temperatures from -65° to $+200^{\circ}\text{C}$ and will operate over the range from -55° to $+150^{\circ}\text{C}$. All devices meet or exceed military environmental specifications of MIL-S-19500.

The GC4400 series will operate typically with $+50$ mA forward bias. Breakdown voltages are available up to 1000 volts.

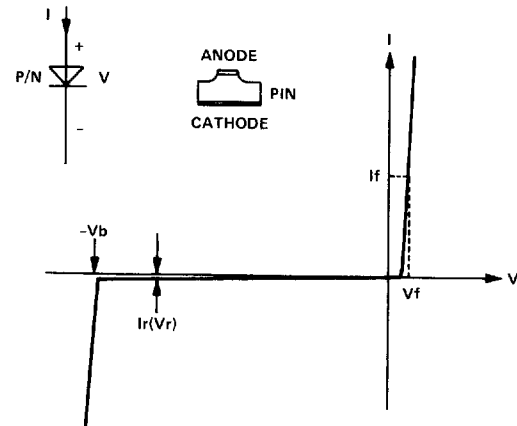
APPLICATIONS

The GC4400 series can be used in RF circuits as an on/off element, as a switch, or as a current controlled resistor in attenuators extending over the frequency range from UHF through Ku band.

Switch applications include high speed switches (ECM systems), TR or lobing switches, channel or antenna selection switches (telecommunications), duplexers (radar) and digital phase shifters (phased arrays).

The GC4400 series can be used in RF circuits as an on/off at moderate RF power levels.

Attenuator type applications include amplitude modulators, AGC attenuators, power levelers and level set attenuators.



ELECTRICAL SPECIFICATIONS

 $T_A = 25^{\circ}\text{C}$

MODEL NUMBER	BREAKDOWN VOLTAGE ($I_R = 10\mu\text{A MAX}$) V_B (MIN)	JUNCTION CAPACITANCE ¹ C_J-50 (MAX)	SERIES RESISTANCE ² (100mA, 1 GHz) R_{S100} (MAX)	CARRIER LIFETIME ($I_R = 6\text{mA}$, $I_F = 10\text{mA}$) T_L (TYP)	THERMAL RESISTANCE θ_{JC} (MAX)
GC4410	100 VOLTS	0.10 pF	0.6 OHMS	2 nsec	30°C/W
GC4411	100	0.25	0.5	.5	25
GC4412	100	0.50	0.4	.7	20
GC4413 ³	100	0.75	0.3	1.0	10
GC4430	300	0.10	1.5	.5	50
GC4431	300	0.25	1.2	1.0	30
GC4432	300	0.50	1.0	1.5	20
GC4433 ³	300	0.75	0.8	2.0	10
GC4490	1000	0.10	1.5	1.0	30
GC4491	1000	0.25	1.2	2.0	25
GC4492	1000	0.50	1.0	3.0	20
GC4493 ³	1000	0.75	0.8	5.0	10
GC4494	1000	1.3	.35	6.0	7
GC4495	1000	2.5	3	7.5	5

NOTES:

- CAPACITANCE IS MEASURED AT 1 MHz AND -50 VOLTS.
- RESISTANCE IS MEASURED USING TRANSMISSION LOSS TECHNIQUES.
- THESE DEVICES ARE NOT AVAILABLE IN ALL CASE STYLES. PLEASE CONSULT THE FACTORY FOR SPECIFIC PACKAGE STYLES OFFERED.

The tabulated specifications above are for case style 30. Diodes are also available in various chip configurations.

Each type offers a trade off in series resistance, junction capacitance, carrier lifetime and breakdown voltage; the proper choice of which depends on the end application. Reverse polarity diodes (NIP) and faster speed PIN and NIP diodes are also available. (See data sheets for GC4500, GC4200, and GC4300 series respectively.)

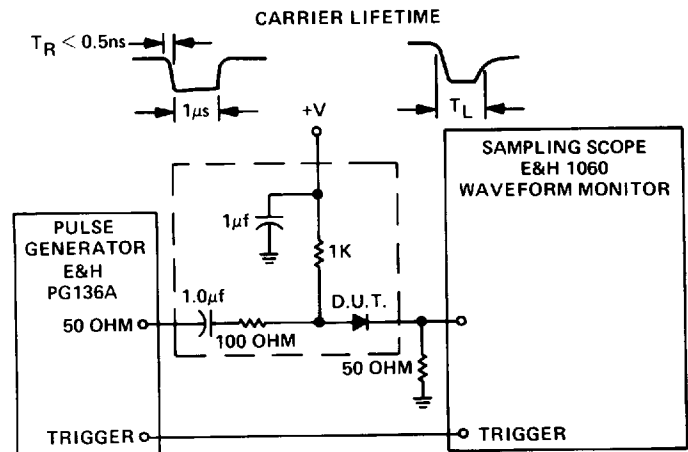
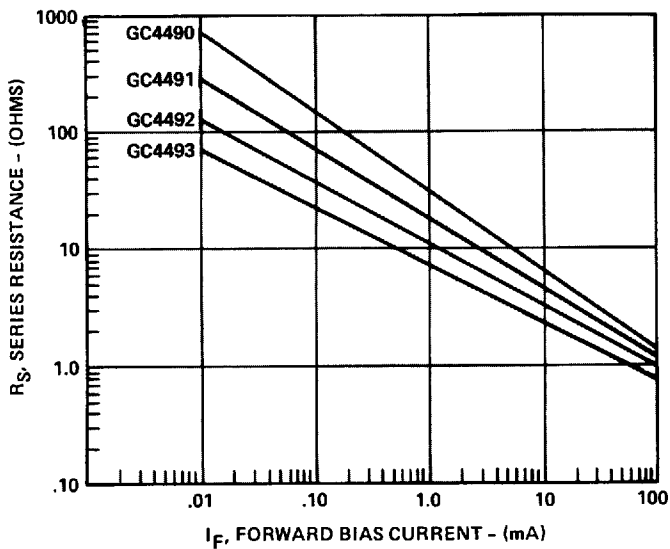
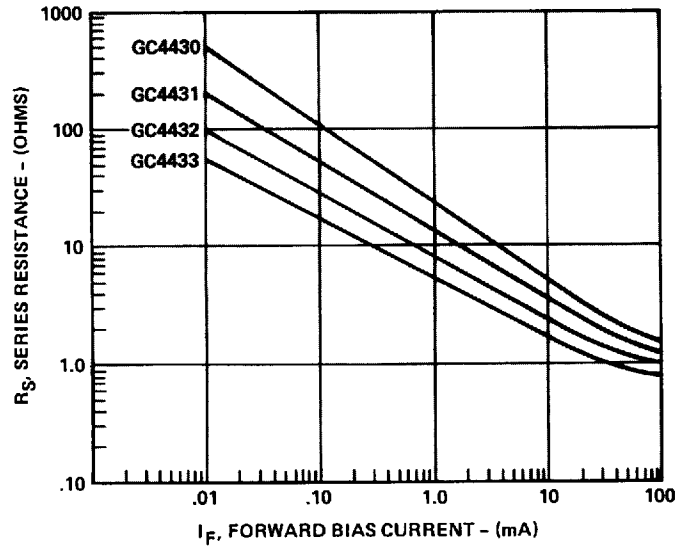
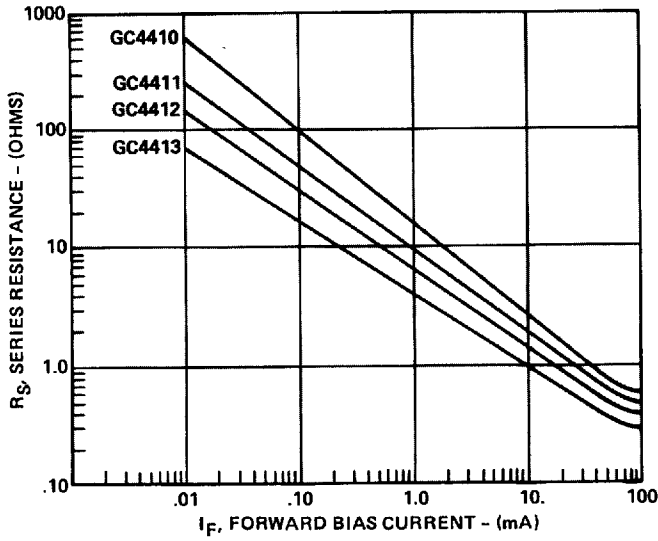
RATINGS

Operating Temperature:	-55°C to $+150^{\circ}\text{C}$
Storage Temperature:	-65°C to $+200^{\circ}\text{C}$
Maximum Leakage Current	$0.5\mu\text{A}$ at 80% of minimum rated breakdown

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TYPICAL PERFORMANCE CURVES

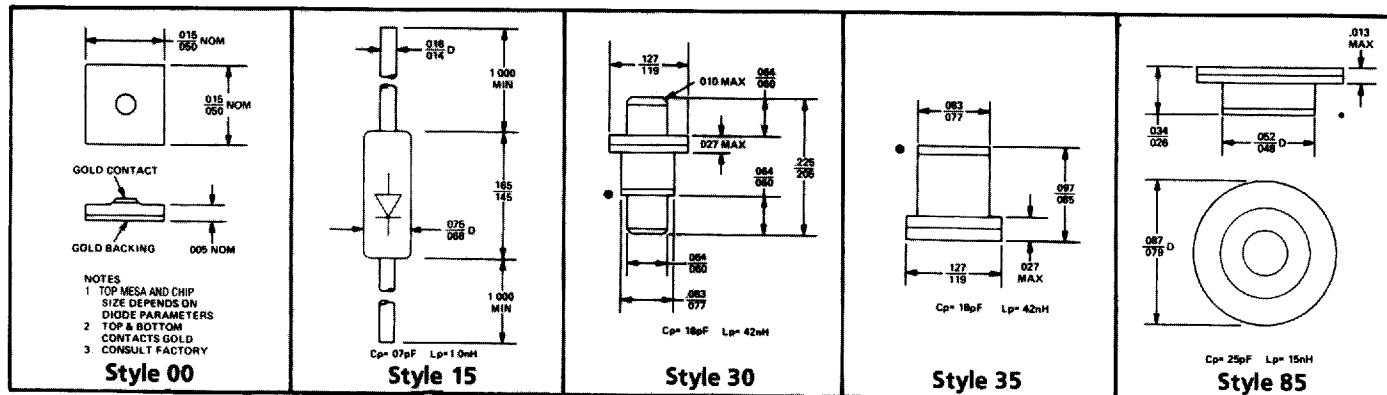


The value of the reverse current (I_R) is approximately 6 mA and the forward current (I_F) is 1.7 I_R . The input pulse is provided by a pulse generator having a rise time of less than one nanosecond. Lifetime is measured between 50% and 90% points of output pulse as shown.

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PACKAGE STYLES



(•) Heat sink end. Dimensions are in inches.

Note: See Semiconductor Package Outlines sheet for complete outline drawings of all cases.

Other Package Styles Are Available on Request.

The cathode is the heat sink end of each package. Reverse polarity is available at a slightly higher cost.

ENGINEERING NOTES: